

June 6–8 MORIS 2006 Workshop, Endorsed; 12–14 Printing of Functional Materials, Endorsed; 18–22 Electroceramics X, Endorsed; 24–30 Beijing Intl. Materials Week, C-MRS; and 26–28 WoDiM, Endorsed.

To list an event in the Calendar, contact J. Meiksin, Materials Research Society, 506 Keystone Drive, Warrendale, PA 15086-7573; 724-779-3004 ext. 522; fax 724-779-8313; bulletin@mrs.org.

MRS, A-MRS, B-MRS, C-MRS, E-MRS, MRS-A, MRS-I, MRS-J, MRS-K, MRS-R, MRS-S, MRS-T, M-MRS, or IUMRS at the end of an entry indicates sponsorship or co-sponsorship of an event by the International Union of Materials Research Societies or one of its adhering bodies. "Endorsed" identifies events endorsed by MRS.

▼ identifies a new or revised entry this month.

See the March 2006 MRS BULLETIN for May 2006 Calendar entries. For updates, access www.mrs.org.

JUNE 2006

3–8 IEEE Intl. Conf. on Plasma Sciences (ICOPS), *Acme, MI*. Claire Rosser, Michigan State University, Rm. B100 RCE, East Lansing, MI, 48824; 517-432-8711; fax 517-432-8714; e-mail crosser@egr.msu.edu; www.icops2006.org.

4–9 Intl. Conf. on Modern Materials Science and Technology (CIMTEC), *Acireale, Italy*. Corso Mazzini, CIMTEC, 52—P.O. Box 174 48018, Faenza, Italy; 39-546-22461; fax 39-546-664138 e-mail congress@technagroup.it; www.cimtecongress.org.

5–8 2nd Intl. FIB Congress 2006 (Intl. Federation for Structural Concrete), *Naples, Italy*. Secretariat FIB Congress, University of Naples Federico II, via Claudio, 21 - 80125, Naples, Italy, e-mail fib2006@unina.it; www.naples2006.com.

6–7 Medical Polymers 2006, *Cologne, Germany*. Rapra Technology, Shawbury, Shrewsbury, SY4 4NR, UK, 44-0-1939-250383; fax 44-0-1939-251118; e-mail conferences@rapra.net; www.rapra.net/conferences/medicalpolymers06.

6–8 Magneto-Optical Recording Intl. Symp. 2006 (MORIS 2006) Workshop, *Chiba Prefecture, Japan*. MORIS 2006 Workshop Secretariat, Proactive Inc., Promena Kobe 16F, 1-8-1, Higashikawasaki-cho, Chuo-ku, Kobe 650-0044, Japan; 81-78-366-5050; fax 81-78-366-5051; moris2006ws@pac.ne.jp; www.ecs.cst.nihon-u.ac.jp/moris2006ws. Endorsed.

7–9 Intl. Conf. on Monitoring, Simulation, Prevention and Remediation of Dense and Debris Flows, *Rhodes, Greece*. Wessex Institute of Technology Conferences, Ashurst Lodge, Ashurst, Southampton, SO40 7AA, UK, 44-0-238-029-3223; fax 44-0-238-029-2853; e-mail enquiries@wessex.ac.uk; www.wessex.ac.uk/conferences/2006/debris06.

8–10 IEEE Intl. Symp. on Technology and Society (ISTAS), *Queens, NY*. Clinton Andrews, Rutgers University, 33 Livingston Ave. #302, New Brunswick, NJ, 08901; 732-932-3822 ext721; fax 732-932-2253; e-mail c.j.andrews@ieee.org; www.ieeesit.org.

11–15 Advanced Membrane Technology III: Membrane Engineering for Process Intensification, *Cetraro, Italy*. ECI, 6 Metro Tech Center, Brooklyn, NY 11201; 718-260-3743; fax 718-260-3754; e-mail info@eci.poly.edu; www.engconfintl.org/6aj.html.

11–15 Intl. Conf. on Transport Phenomena in Micro and Nanodevices, *Barga, Italy*. ECI, 6 Metro Tech Center, Brooklyn, NY 11201; 718-260-3743; fax 718-260-3754; e-mail info@eci.poly.edu; www.engconfintl.org/6at.html.

11–16 Gordon Research Conf. on Ligand Recognition and Molecular Gating, *Barga, Italy*. Benjamin Kaupp, Research Centre Juelich, IBI-1, Juelich 52428, Germany, e-mail a.eckert@fz-juelich.de; www.grc.org/programs/2006/ligand.htm.

11–16 Gordon Research Conf. on Multiphoton Processes, *Tilton, NH*. Robert Jones, University of Virginia, 382 McCormick Road, PO Box 400714, Charlottesville, VA, 22904-4714; e-mail rj3c@virginia.edu; www.grc.org/programs/2006/multipho.htm.

12–14 Intl. Conf. Advances in Fusion and Processing of Glass, *Dresden, Germany*. German Society of Glass Technology (DGG), Siemensstrabe 45, 63071 Offenbach, Germany; 49-0-69-975861-0; fax 49-0-69-975861-99; e-mail dgg@hvg-dgg.de; www.hvg-dgg.de/de/8th_international_conference.htm.

12–14 Printing of Functional Materials: Fundamental Chemistry and Materials Science, *Manchester, UK*. RSC Conferences, Thomas Graham House, Science Park, Milton Road, Cambridge CB4 0WF, UK, 44-0-1223-432254; fax 44-0-1223-423623; www.rsc.org/ConferencesAndEvents/RSCConferences/PFM. Endorsed.

12–15 Microwave Materials and their Applications, *Oulu, Finland*. MMA 2006, Microelectronics and Materials Physics Laboratories, Dept. of Electrical Engineering, University of Oulu, Linnanmaa, FIN-90570 Oulu, Finland; mma2006@ee.oulu.fi; www.ee.oulu.fi/research/miklab/mma2006.

12–16 Great Lakes Photonics Symp. 2006, *Dayton, OH*. SPIE Meetings, P.O. Box 10, Bellingham, WA, 98227-0010; 360-676-3290; fax 360-647-1445; e-mail spie@spie.org; spie.org/Conferences/calls/06/gl.

13–16 Northern Optics (NO2006), *Bergen, Norway*. Gerd Pettersen, Instituttvegen 25, PO Box 70, NO-2027 Kjeller, Norway, 47-6484-4703; fax 47-6381-8146; e-mail gerd@unik.no; web.unik.no/NO2006.

15–16 ▼ Biotechnological Technologies 2006—Technological Responses to Biological Threats, *Washington, DC*. Knowledge Foundation, 18 Webster Street, Brookline, MA, 02446-4938; 617-232-7400; fax 617-232-9171; e-mail custserv@knowledgefoundation.com; www.knowledgefoundation.com.

17–21 MPIF Intl. Conf. on Powder Metallurgy and Particulate Materials (PowderMet 2006), *San Diego, CA*. MPIF, 105 College Road East, Princeton, NJ, 08540; 609-452-7700; fax 609-987-8523; e-mail info@mpif.org; www.mpiif.org/Meetings.

18–21 ACS Colloid and Surface Science Symp., *Boulder, CO*. Daniel Schwartz, University of Colorado, Dept. of Chemical Engineering, Boulder, CO 80309-0424; 303-735-0240; fax 303-492-4341; e-mail daniel.schwartz@colorado.edu; www.colloid.org.

18–22 Electroceramics X, *Toledo, Spain*. Instituto de Cerámica y Vidrio, Sociedad Española de Cerámica y Vidrio, Kelsen 5, 28049 Cantoblanco, Madrid, Spain, 34-91-735-58-40; fax 34-91-735-58-43; e-mail electroceramics-x@icv.csic.es; www.estyloweb.com/electroceramics-x. Endorsed.

18–23 Gordon Research Conf. on Basement Membranes, *Barga, Italy*. Reinhard Faessler, Max Planck Institute for Biochemistry, Dept. Molecular Medicine, Am Klopferspitz 18A, Martinsried D-82152, Germany, e-mail faessler@biochem.mpg.de; www.grc.org/programs/2006/basement.htm.

18–23 Gordon Research Conf. on Tribology, *Waterville, ME*. Tom Dickinson, Washington State University, Department of Physics, Pullman, WA, 99164-2814; e-mail jtd@wsu.edu; www.grc.org/programs/2006/tribo.htm.

19–21 ▼ Intl. Congress on Nanobiotechnology and Nanomedicine (NanoBio 2006), *San Francisco, CA*. International Association of Nanotechnology, Inc, 2386 Fair Oaks Boulevard, Sacramento, CA, 95825; 916-529-4119; fax 916-421-6366; e-mail info@ianano.org; www.nanobio2006.com.

19–23 Cell-Materials Interactions: Regenerative Medicine, *Porto, Portugal*. Secretariat Cell-Material Interactions, Universidade do Porto, Biomaterials Laboratory, Rua do Campo Alegre, 823, 4150-180, Porto, Portugal, 35-1-22-6074982; fax 35-1-22-6094567; e-mail info@ineb.up.pt; http://www.ineb.up.pt.

21–25 ASME 2006 Summer Bioengineering Conf., *Amelia Island, FL*. Barry Lieber, University of Miami, Biomedical Engineering, Rm 203 McArthur Annex, 1251 Memorial Drive, Coral Gables, FL 33146; e-mail blieber@miami.edu; divisions.asme.org/bed/events/summer06.html.

24–30 Beijing Intl. Materials Week, *Beijing, China*. Lin Jianyun, Room 4102, 62 Zizhuyuan Road, Beijing, China, 86-10-68722031; fax 86-10-68722033; e-mail 2006BIMW@sohu.net; www.c-mrs.org.cn/ehuiyi_list.asp. C-MRS.

25–29 Intl. Congress on Ceramics, *Toronto, Ontario*. American Ceramic Society, Suite 100, Westerville, OH, 43081; 614-890-4700; fax 614-899-6109; e-mail info@ceramics.org; www.ceramics.org/meetings/icc.

25–30 Gordon Research Conf. on MEMS Technology and Biomedical Applications, *New London, CT*. Rafael Kleiman, McMaster University, Engineering Physics Dept., 1280 Main Street West, Hamilton, ON L8S 4L7, Canada; e-mail kleiman@mcmaster.ca; www.grc.org/programs/2006/mems.htm.

25–30 Gordon Research Conf. on Permeable Sediments, *Waterville, ME*. Carolyn Oldham, University of Western Australia, Center for Water Research, 35 Stirling Highway, Crawley, WA 6009, Australia, e-mail c.oldham@cwr.uwa.edu.au; www.grc.org/programs/2006/permsed.htm.

25–30 Gordon Research Conf. on Three Dimensional Electron Microscopy, *Barga, Italy*. Helen Saibil, Birkbeck College, Crystallography Dept., Malet Street, London WC1E 7HX, UK, e-mail h.saibil@mail.cryst.bbk.ac.uk; www.grc.org/programs/2006/threed.htm.

25–30 Novel and Emerging Ceramics and Composites, *Kona Coast, HI*. ECI 6 Metro Tech Center, Brooklyn, NY 11201; 718-260-3743, fax 718-260-3754; e-mail info@eci.poly.edu; www.engconfintl.org/6afbody.html.

26–28 ▼ Device Research Conf., *University Park, PA*. Judy Meder, The Pennsylvania State University, 225 The Penn State Conference Center Hotel, University Park, PA, 16803; 814-863-5100; e-mail ConferencelInfo1@outreach.psu.edu; drc.ee.psu.edu.

26–28 IASTED Intl. Conf. on Applied Simulation and Modelling, *Rhodes, Greece*. Secretariat IASTED, #80, 4500 16th Ave. N.W., Calgary, AB, T3B 0M6; 403-288-1195; fax 403-247-6851; e-mail calgary@iasted.org; www.iasted.org/conferences/2006/Greece/c522.htm.

26–28 ▼ Workshop on Dielectrics in Microelectronics (WoDiM), *Santa Tecla, Italy*. CNR-IMM, WoDiM 2006, Stradale Primosole, 50, Catania, Italy, 39-095-5968-223; fax 39-095-5968-321; e-mail wodim2006@imm.cnr.it; www.imm.cnr.it/wodim_2006. Endorsed.

26–29 ECM VII: Cartilage & Joint Repair, *Davos, Switzerland*. Sonia Wahl, AO Research Institute, Clavadelerstrasse, CH-7270 Davos Platz, Davos, Switzerland, 41-81-41-42-541; fax 41-81-41-42-299; e-mail sonia.wahl@aofoundation.org; www.ecmjournal.org/ecm_meetings/ecm7.

26–29 Intl. Energy Conversion Engineering Conf. (IECEC 2006), *San Diego, CA*. Michael Piszczor, NASA Glenn Research Center, Cleveland, OH, 44135; 216-433-2237; e-mail michael.piszczor@grc.nasa.gov; www.aiaa.org/events/iecec.

26–30 IEEE Intl. Conf. on Properties and Applications of Dielectric Materials (ICPADM), *Bali, Indonesia*. Dr. Suwarno, Bandung Institute of Technology, Jl. Ganesha 10, Bandung, Indonesia, 62-22-250-2260; fax 62-22-253-4222; e-mail suwarno@ieee.org; www.icpdm2006.com.

26–30 National Space and Missile Materials Symp., *Orlando, FL*. Dan Cleyrat, National Space & Missile Materials Symposium, C/O: Anteon Corporation, 5100 Springfield Pike, Suite 509, Dayton, OH 45431, 937-656-6482; fax 937-254-2153; e-mail daniel.cleyrat@wpafb.af.mil; www.usasymposium.com/nsmmms.

28–29 TMS Electronic Materials Conf. (EMC), *University Park, PA*. TMS Meetings Services, 184 Thorn Hill Road, Warrendale, PA, 15086; 724-776-9000 x243; fax 724-776-3770; e-mail mtgserv@tms.org; www.tms.org/EMC.html.

30–4 ▼ Intl. Conf. on Nanoscience and Technology (ICN&T 2006), *Basel, Switzerland*. ICN&T 2006, c/o AKM Congress Service, Clarastrasse 57, CH-4005, Basel, Switzerland, 41-61-686-77-11; fax 41-61-686-77-88; e-mail info@akm.ch; www.icnt2006.ch.

JULY 2006

2–6 European Conf. on Foams, Emulsions and Applications (EUFOAM 2006), *Potsdam, Germany*. Reinhard Miller, Max Planck Institut Colloids and Interfaces, Am Muelenberg 1, D-14476 Potsdam-Golm, Germany; 49-331-567-9252; fax 49-331-567-9202; e-mail eufoam2006@mpikg.mpg.de; www.mpihg.mpg.de/en/gf/eufoam2006.

2–6 Gordon Research Conf. on Defects In Semiconductors, *New London, NH*. Wladek Walukiewicz, Lawrence Berkeley National Laboratory, 1 Cyclotron Road, MS 2-200, Berkeley, CA, 94720; e-mail w_walukiewicz@lbl.gov; www.grc.org/programs/2006/defects.htm.

2–7 21st International Liquid Crystal Conference, *Keystone, CO*. Kinsley & Associates, Conference Management Office, LLC, 303-798-3664; ilcc@kinsleyassociates.com; www.ilcc2006.com.

2–7 Gordon Research Conf. on Vibrational Spectroscopy, *Biddeford, ME*. F. Fleming Crim, University of Wisconsin, Department of Chemistry, 1101 University Ave., Madison, WI, 53706; e-mail fcrim@chem.wisc.edu; www.grc.org/programs/2006/vibrat.htm.

2–8 ▼ Intl. Conf. on Composites/Nano Engineering (ICCE-14), *Boulder, CO*. David Hui, University of New Orleans, Dept. of Mechanical Engineering, New Orleans, LA 70148; 504-280-6652; fax 504-280-6192; e-mail dhui@uno.edu; myweb.polyu.edu.hk/~mmktlau/ICCE/ICCE_Main.htm.

3–7 European Conf. of Fracture, *Alexandroupolis, Greece*. Emmanuel Gdoutos, Democritus University of Thrace, School of Engineering, GR-671 00, Xanthi, Greece, 30-25410-79651; fax 30-25410-79652; e-mail egdoutos@civil.duth.gr; ecf16.civil.duth.gr.

4–8 Intl. Conf. on Processing and Manufacturing of Advanced Materials, *Vancouver, Canada*. Tatiana Joksimovic, Services Suite 645, 375 Water Street, Vancouver, BC, V6B 5C6, Canada; 604-681-2503; fax 604-681-5226; e-mail thermec2006@venuewest.com; thermec.uow.edu.au.

5–7 Intl. Conf. on Advanced Computational Methods and Experimental Measurements in Heat and Mass Transfer, *The New Forest, UK*. Wessex Institute of Technology Conferences, Ashurst Lodge, Ashurst, Southampton SO40 7AA, UK, 44-0-238-029-3223; fax 44-0-238-029-2853; e-mail enquiries@wessex.ac.uk; www.wessex.ac.uk/conferences/2006/heat06.

5–7 Intl. Symp. on Organocatalysis in Organic Synthesis, *Glasgow, UK*. RSC Conferences, Thomas Graham House, Science Park, Milton Road, Cambridge CB4 0WF, UK, 44-0-1223-432254; fax 44-0-1223-423623; www.rsc.org/ConferencesAndEvents/RSCConferences/organocat06.

9–12 Fractography of Glasses and Ceramics V, *Rochester, NY*. The American Ceramic Society, 735 Ceramic Place, Suite 100, Westerville, OH 43081; 614-890-4700; fax 614-899-6109; e-mail info@ceramics.org; engineering.alfred.edu/outreach/conf/fractography.

9–12 Intl. Symp. on New Materials for Electrochemical Systems, *Montréal, Canada*. Secretariat New Materials 2006, Bureau des Congrès Universitaires, 6600 Côte-des-Neiges Road, Suite 510, Montreal, Quebec, H3S 2A9 Canada; 514-340-3215; fax 514-340-4440; e-mail newmat@congresbcu.com; newmaterials.congresbcu.com.

9–13 Structure and Dynamics of Self-Organized Macromolecular Systems, *Prague, Czech Republic*. Petr Štěpánek, Institute of Macromolecular Chemistry, Heyrovského nám. 2, CZ-162 06 Praha 6, Praha, Czech Republic, 420-296-809-332; fax 420-296-809-410; e-mail sympo@imc.cas.cz; www.imc.cas.cz/sympo/45micros.html.

10–11 ▼ CEAC Summer Workshop on: Nanoanalysis, *Zürich, Switzerland*. Fiona Ford, Center of Excellence in Analytical Chemistry, HCI E325, ETH Hönggerberg, CH-8093, Zürich, Switzerland, 41-44-632-43-77; fax 41-44-632-12-92; e-mail ford@org.chem.ethz.ch; www.ceac.ethz.ch.

10–12 Faraday Discussion 134: Atomic Transport and Defect Phenomena in Solids, *Guildford, UK*. RSC Conferences, Thomas Graham House, Science Park, Milton Road, Cambridge CB4 0WF, UK, 44-0-1223-432254; fax 44-0-1223-423623; www.rsc.org/ConferencesAndEvents/RSCConferences/FD134.

10–12 Intl. Association for Boundary Element Methods (IABEM) Conf., *Graz, Austria*. Martin Schanz, Graz University of Technology, Institute of Applied Mechanics, Technikerstr. 4, A-8010, Graz, Austria, 43-316-873-7640; fax 43-316-873-7641; e-mail iabem2006@tugraz.at; www.iabem2006.tugraz.at.

10–12 Intl. Meeting on High Performance Computing for Computational Science (VECPAR2006), *Rio de Janeiro, Brazil*. Suely Lima, IMPA/Scientific Activities Department (DAC), Estrada Dona Castorina, 110, Jardim Botânico, Rio de Janeiro, RJ, Brazil, 22460-320, 55-21-25295277; fax 55-21-25295019; e-mail dac@impa.br; vecpar.fe.up.pt/2006.

14–16 ▼ 2006 WSEAS Intl. Conf. on Cellular and Molecular Biology—Biophysics and Bioengineering, *Athens, Greece*. P. Anninos, Democritus University of Thrace, Medical Physics Laboratory, Alexandroupolis, Greece, e-mail info@wseas.org; worlds.es.org/conferences/2006/greece/bio/committee.htm.

16–20 IEEE Conf. on Nanotechnology (IEEE-NANO), *Cincinnati, OH*. Clifford Lau, Institute for Defense Analyses, 4850 Mark Center Drive, Alexandria, VA, 22311; 703-933-6525; fax 703-845-6848; e-mail clau@ida.org; www.ecacs.uc.edu/~mcahay/Nano2006/index2006.html.

16–20 NC-AFM2006 9th Intl. Conf. on Noncontact Atomic Force Microscopy, *Kobe, Japan*. Masayuki Abe, Osaka University, Japan, e-mail ncafm.ele.eng.osaka-u.ac.jp; ncafm.ele.eng.osaka-u.ac.jp.

16–21 2006 Gordon Conf. on High Temperature Materials, Processes, and Diagnostics, *Waterville, ME*. www.grc.uri.edu. Endorsed.

16–21 Gordon Research Conf. on Inorganic Chemistry, *Newport, RI*. Bahram Moasser, GE Global Research Center, Bldg CE, Room 134, One Research Circle, Niskayuna, NY, 12309; e-mail moasser@crd.ge.com; www.grc.org/programs/2006/inorchem.htm.

16–21 Gordon Research Conf. on Plasma Processing Science, *South Hadley, MA*. Alexander Fridman, Drexel University, MEM Dept., 3141 Chestnut Street, Philadelphia, PA, 19104; e-mail fridman@drexel.edu; www.grc.org/programs/2006/plasma.htm.

16–22 World Congress on Computational Mechanics, *Los Angeles, CA*. WCCM 2006, e-mail wccm2006@seas.ucla.edu; www.wccm2006.northwestern.edu.

22–26 Annual Meeting and Exposition of the Controlled Release Society, *Vienna, Austria*. Controlled Release Society, 3650 Annapolis Lane North, Suite 107, Minneapolis, MN 55447-5434; 763-512-0909; fax 763-765-2329, e-mail meetings@controlledrelease.org; www.controlledrelease.org.

23–28 Gordon Research Conf. on Granular and Granular-Fluid Flow, *Oxford, UK*. Christine Hrenya, University of Colorado, Dept. of Chemical and Biological Engineering, UCB 424, Boulder, CO, 80309; e-mail hrenya@colorado.edu; www.grc.org/programs/2006/granular.htm.

23–28 Gordon Research Conf. on Physical Metallurgy, *Plymouth, NH*. Alex King, Purdue University, School of Materials Engineering, 501 Northwestern Avenue, West Lafayette, IN, 47907-2044; e-mail alexking@ecn.purdue.edu; www.grc.org/programs/2006/phymet.htm.

23–28 Intl. Conf. on the Physics and Chemistry of Ice, *Bremerhaven, Germany*. PCI 2006, e-mail info@pcice2006.de; www.pcice2006.de.

29–4 ▼ 5th World Congress of Biomechanics, *Munich, Germany*. Joyce McLean, Munich University of Applied Sciences, Laboratory of Biofluid Mechanics, Dept. of Supply Engineering 05, Lothstr. 34, D-80335 Munich, Germany, e-mail joyce.mclean@t-online.de; www.wcb2006.org.

30–2 Fifth Intl. Conf. on Synchrotron Radiation in Materials Science, *Chicago, IL*. www.aps.anl.gov/News/Conferences/2006/SRMS/. Endorsed.

30–2 IEEE Intl. Symp. on Applications of Ferroelectrics, *Sunset Beach, NC*. Jon-Paul Maria, 1001 Capability Drive, Research Building One, Office 322, Raleigh, NC 27606; 919-513-2843; fax 919-515-3419; e-mail jpmaria@ncsu.edu; www.ieee-uffc.org.

30–3 Advances in Materials and Processing Technologies (AMPT), *Las Vegas, NV*. Patricia Davidson, Ohio University, Community and Professional Programs, 113 Haning Hall, Athens, OH 45701, 740-593-1767; fax 740-593-9476; e-mail davidson@ohio.edu; www.ohiou.edu/amp.

30–3 ▼ Mali Symp. on Applied Sciences, *Bamako, Mali*. Fad Seydou, University of Maryland, Mechanical Engineering, 3125 Martin Hall, College Park, MD 20742-3035, 301-405-5261; e-mail fad@umiacs.umd.edu; www.msas.maliwatch.org/msas2006/html/call06E.html.

30–3 Microscopy and Microanalysis 2006, *Chicago, IL*. Microscopy/Marketing & Education, Inc., Microscopy & Microanalysis Meeting Management, 125 Parido Street, Suite 102, Springfield, MA, 01118-2130; 972-954-8011; fax 972-954-8018; e-mail corporate@mme1.com; mm2006.microscopy.org.

30–4 Gordon Research Conf. on Biomineralization, *New London, NH*. Joanna Aizenberg, Lucent Technologies, Bell Laboratories, 700 Mountain Avenue, Room 1C-365, Murray Hill, NJ 07974-2008, e-mail jaizenberg@lucent.com; www.grc.org/programs/2006/biomin.htm.

30–4 Gordon Research Conf. on Flow and Transport In Permeable Media, *Andover, NH*. Martin Blunt, Imperial College, Dept. of Earth Science and Engineering, London SW7 2AZ, UK, e-mail m.blunt@imperial.ac.uk; www.grc.org/programs/2006/flow.htm.

30–4 Gordon Research Conf. on Thin Film and Small Scale Mechanical Behavior, *Waterville, ME*. Zhigang Suo, Harvard University, Engineering and Applied Sciences Div., 29 Oxford Street, Pierce Hall 309, Cambridge, MA, 02138; e-mail suo@deas.harvard.edu; www.grc.org/programs/2006/thinfilm.htm.

30–4 ICN&T2006 Intl. Conf. on Nanoscience and Technology, *Basel, Switzerland*. ICN&T 2006, c/o AKM Congress Service, Clarastrasse 57, CH-4005 Basel, Switzerland, 41-61-686-77-11; fax 41-61-686-77-88; e-mail info@akm.ch; www.icnt2006.ch.

31–4 Intl. Conf. on Ultrafast Phenomena, *Pacific Grove, CA*. Optical Society of America, 2010 Massachusetts Ave., NW, Washington, 202-223-8130; fax 202-223-1096; e-mail info@osa.org; www.osa.org/meetings/topicals/up.

AUGUST 2006

5-9 Symp. of The Protein Society, *San Diego, CA*. Jean Lash, FASEB/OSMC, 9650 Rockville Pike, Bethesda, MD, 20814; 301-634-7009; fax 301-634-7014; e-mail jlash@faseb.org; www.faseb.org/meetings.

6-10 IMS Annual Convention, *Chicago, IL*. ASM International Customer Service, 9639 Kinsman Road, Materials Park, OH 44073-0002; 800-336-5152 ext. 6; fax 440-338-4634; customer.service@asminternational.org; www.asminternational.com.

6-11 Gordon Research Conf. on Macromolecular Organization and Cell Function, *South Hadley, MA*. Ronald Lynch, University of Arizona, Arizona Health Sciences Center, Dept. of Physiology, Tucson, AZ, 85724; e-mail rlynch@u.arizona.edu; www.grc.org/programs/2006/macromol.htm.

6-11 Gordon Research Conf. on Science of Adhesion, *Tilton, NH*. William Unertl, University of Maine, Physics and Astronomy Dept., Bennett Hall, Orono, ME 04469; e-mail unertl@maine.edu; www.grc.org/programs/2006/adhesion.htm.

13-17 SPIE—Optics and Photonics, *San Diego, CA*. SPIE, P.O. Box 10, Bellingham, WA 98227-0010; 360-676-3290; fax 360-647-1445; e-mail spie@spie.org; spie.org/app/conferences.

13-18 Gordon Research Conf. on Electron Donor Acceptor Interactions, *Newport, RI*. Clifford Kubiak, University of California, San Diego, Dept. of Chemistry and Biochemistry, 9500 Gilman Dr., La Jolla, CA 92093-0358; e-mail ckubiak@ucsd.edu; www.grc.org/programs/2006/electdon.htm.

13-18 Gordon Research Conf. on Science and Technology Policy, *Big Sky, MT*. Frederick Grinnell, UT Southwestern Medical Center, Dept. of Cell Biology 5323 Harry Hines Blvd., Dallas, TX, 75230; e-mail frederick.grinnell@utsouthwestern.edu; www.grc.org/programs/2006/policy.htm.

14-15 Mammalian Cell Culture: Stabilizing Stem Cell Research, Sustaining Tissue Modeling, and Cultivating Cellular Therapeutics, *Boston, MA*. Shelley Amster, Cambridge Healthtech Institute, 1037 Chestnut Street, Newton Upper Falls, MA 02464, 617-630-1373, fax 617-630-1325; e-mail samster@healthtech.com; www.healthtech.com/2006/cst/index.asp.

14-16 Stem Cell Research, *Boston, MA*. Mary Ann Brown, Cambridge Healthtech Institute, 1037 Chestnut St., Newton Upper Falls, MA, 02464; 617-630-1397; fax 617-630-1325; e-mail mabrown@healthtech.com; www.healthtech.com/2006/stm/index.asp.

14-18 IEEE Intl. Symp. on Electromagnetic Compatibility (EMC 2006), *Portland, OR*. Vita Feuerstein, IEEE, 445 Hoes Lane, Piscataway, 732-562-6826; fax 732-981-1203; e-mail vita@ieee.org; www.emc2006.org.

14-26 Advanced Workshop on Physics of Cellular Objects, *Corsica, France*. Advanced Workshop on Physics of Cellular Objects, Corsica, France, e-mail cargese2006@free.fr; cargese2006.free.fr.

15-16 Tissue Models for Therapeutic Development, *Boston, MA*. Mary Ann Brown, Cambridge Healthtech Institute, 1037 Chestnut St., Newton Upper Falls, MA, 02464; 617-630-1397; fax 617-630-1325; e-mail mabrown@healthtech.com; www.healthtech.com/2006/tbs/index.asp.

19-23 ACS National Meeting & Exposition, *Boston, MA*. National Expositions American Chemical Society, 1155 Sixteenth Street, Washington, DC, 20036; e-mail expo@acs.org; www.chemistry.org/expositions.

19-25 World Renewable Energy Congress and Exhibition, *Florence, Italy*. Ali Sayigh, PO Box 362, Brighton BN2 1YH, United Kingdom, 44-1273-625-643; fax 44-1273-625-768; e-mail asayigh@netcomuk.co.uk; www.wrenuk.co.uk/wrecix.html.

20-24 Intl. Materials Research Congress, *Cancun, Mexico*. Ladrillera de Benítez, 29 Oriente #601-1, C.P. 72540, Puebla, Mexico, 52-222-2-11-43-93; fax 52-222-2-11-43-94; e-mail imrc@mail.buap.mx; www.imrc2006.buap.mx. **M-MRS**

20-25 Gordon Research Conf. on Drug Carriers In Medicine and Biology, *Big Sky, MT*. Alexander Kabanov, Univ. of Nebraska Medical Center, 985830 Nebraska Medical Center, Omaha, NE 68198-5830; e-mail akabanov@unmc.edu; www.grc.org/programs/2006/drugcarr.htm.

20-25 Intl. Conf. on the Application of Accelerators in Research and Industry, *Fort Worth, TX*. Margaret Hall, University of North Texas, PO Box 311427, Denton, TX, 76203-1427; 940-565-3250; fax 940-565-2227; e-mail caari2006@unt.edu; www.caari2006.com.

20-26 Intl. Conf. on Nanostructured Materials, *Bangalore, India*. Prof. K. Chattopadhyay, Dept. of Metallurgy, Indian Institute of Science, Bangalore 560 012, India; 91-80-22932262; fax 91-80-23601991; e-mail nano2006@met.iisc.ernet.in; met.iisc.ernet.in/~nano2006.

21-24 IEEE/LEOS Intl. Conf. on Optical MEMs and Their Applications (MOEMS), *Big Sky, MT*. IEEE/LEOS, 445 Hoes Lane, PO Box 1331, Piscataway, NJ, 08855; 732-562-3899; fax 732-562-8434; e-mail leosconferences@ieee.org; www.i-leos.org.

21-25 Intl. Conf. on Biomagnetism, *Vancouver, British Columbia*. Secretariat Biomag 2006, c/o Venue West Conference Services Ltd., 645 - 375 Water Street, Vancouver, BC, Canada V6B 5C6; 604-681-5226; fax 604-681-2503; e-mail congress@venuewest.com; www.biomag2006.ca.

23-25 NESAC/BIO Workshop on Surface Characterization of Biomaterials, *Seattle, WA*. University of Washington, NESAC/BIO—National ESCA and Surface Analysis Center, Depts. of Bioengineering and Chemical Engineering Box 351750, Seattle, WA 98195-1750, 206-685-1229; fax 206-543-3778; e-mail info@nb.engr.washington.edu; www.nb.engr.washington.edu.

26-27 GIA Gemological Research Conf., *San Diego, CA*. GIA, 5345 Armada Drive, Carlsbad, CA 92008-4602; 760-603-4019; fax 760-603-4021; e-mail gemconference@gia.edu; www.gia.edu/newsroom/608/21821/news_release_details.cfm.

26-30 Polycondensation 2006, *Istanbul, Turkey*. Iskender Yilgor, e-mail iyilgor@ku.edu.tr; polycond2006.ku.edu.tr.

27-31 TMS—Sohn Intl. Symp. on Advanced Materials: Principles, Technologies, and Industrial Practice, *San Diego, CA*. TMS Meetings Services, 184 Thorn Hill Road, Warrendale, PA, 15086; 724-776-9000 x243; fax 724-776-3770; e-mail mtgserv@tms.org; www.tms.org/Meetings/Specialty/FallExt2006/FallExt2006-Home.html. **Endorsed.**

27-31 World Congress on Medical Physics and Biomedical Engineering (WC 2006), *Seoul, South Korea*. Secretariat WC 2006, SL Gangnam, PO Box 305, Seoul, Korea (South), 82-2-3476-7700; fax 82-2-3476-8800; e-mail wc2006@kocconex.com; www.wc2006-seoul.org.

29-1 Conf. on Computational Physics (CCP 2006), *Gyeongju, South Korea*. CCP 2006, e-mail asw@physics.postech.ac.kr; ccp2006.postech.edu.

30-3 Intl. Conf. of the IEEE Engineering in Medicine and Biology Society, *New York, NY*. Jodi Strock, IEEE/EMBS, 445 Hoes Lane, Piscataway, 732-562-3451; fax 732-981-1769; e-mail j.strock@ieee.org; www.ieee.org.

SEPTEMBER 2006

3-7 Polymer Networks Group Conf. 2006—Functional and Biological gels and networks: theory and experiment, *Sheffield, UK*. Shelagh Cowley, University of Sheffield, Dainton Building, Brook Hill, Sheffield, UK, 44-0-114-222-9537; fax 44-0-114-222-9389; e-mail s.h.cowley@sheffield.ac.uk; www.polymernetworks.group.shef.ac.uk.

3-8 Gordon Research Conf. on Bioelectrochemistry, *Aussos, France*. Justin Teissie, CNRS, Inst. of Pharma and Struct Biology, 205 Route de Narbonne, UMR 5089, Toulouse, Cedex 31077, France, e-mail justing.teissie@ipbs.fr; www.grc.org/programs/2006/bioelec.htm.

4-8 Trends in Nanotechnology (TNT2006), *Grenoble, France*. Antonio Correia, Fundacion PHANTOMS, Madrid Science Park, Pabellón C, Ctra. Colmenar Viejo Km 15, Ciudad Universitaria de Cantoblanco-UAM, 28049 Madrid, Spain; e-mail antonio@phantomsnet.net; www.tnt2006.org.

5-7 Intl. Conf. on Bioengineering and Nanotechnology, *Santa Barbara, CA*. June Wispelwey, Society for Biological Engineering, 3 Park Avenue, New York, NY, 10016; e-mail junew@aiiche.org; www.aiiche.org/SBE/Events/Conferences.aspx. **Endorsed.**

5-8 European Conf. on Computational Fluid Dynamics (ECCOMAS CFD 2006), *Egmond aan Zee, Netherlands*. Secretariat ECCOMAS CFD 2006, Delft University of Technology, Mekelweg 4, 2628 CD Delft, Delft, Netherlands, 31-0-6-27227520; fax 31-0-10-5112119; e-mail eccomas CFD2006@math.tudelft.nl; www.eccomas CFD2006.nl.

6-8 Intl. Conf. on the Characterization and Control of Interfaces (ICCCI 2006), *Kurashiki, Japan*. Makio Naito, Osaka University, 11-1, Mihogaoka, Ibaraki, Osaka, Japan, 81-6-6879-8660; fax 81-6-6879-8680; e-mail m-naito@jwri.osaka-u.ac.jp; www.jwri.osaka-u.ac.jp/%7Eecon/iccii2006/index.html.

7-9 Asian Consortium for Computational Materials Science (ACCMS), *Sendai, Japan*. Asian Consortium for Computational Materials Science, e-mail accms-admin@imr.edu; www-lab.imr.edu/~accms/.

10-14 ACS National Meeting and Exposition, *San Francisco, CA*. American Chemical Society, attn: National Expositions, 1155 Sixteenth Street, Washington, DC 20036; expo@accs.org; chemistry.org/expositions.

10-14 IUMRS Intl. Conf. in Asia (IUMRS-ICA-2006), *Jeju, Korea*. Hyeontag Jeon, Hanyang University, Division of Materials Science and Engineering, Seongdong-gu, Seoul 133-791, Korea; 82-2-2220-0387; fax 82-2-2292-3523; e-mail ica2006@hanyang.ac.kr; www.cheric.org/~ica2006. **MRS-K, IUMRS, C-MRS, MRS-I, MRS-J, MRS-S, MRS-T.**

10-15 ESOMAT—European Symp. on Martensitic Transformations, *Bochum, Germany*. ESOMAT; e-mail esomat06@ruhr-uni-bochum.de; www.ruhr-uni-bochum.de/esomat06.

10-15 Gordon Research Conf. on Electronic Spectroscopy and Dynamics, *Les Diablerets, Switzerland*. Frederic Merkt, ETH Zuerich, Lab. Fur Physikalische Chemie, ETH Honggerberg, HCI, Zuerich CH-8093, Switzerland; e-mail merkt@xuv.phys.chem.ethz.ch; www.grc.org/programs/2006/electspec.htm.

12-15 Intl. Conf. on Computational Structures Technology (CST 2006), *Las Palmas de Gran Canaria, Spain*. Dun Eaglais, Civil-Comp Limited, Station Brae, Kippen, Stirling, United Kingdom, 44-0-1786-870-166; fax 44-0-1786-870-167; e-mail info@civil-comp.com; www.civil-comp.com/conf/cst2006.htm.

12-15 Intl. Conf. on Engineering Computational Technology (ECT 2006), *Las Palmas de Gran Canaria, Spain*. Dun Eaglais, Civil-Comp Limited, Station Brae, Kippen, Stirling, UK; 44-0-1786-870-166; fax 44-0-1786-870-167; e-mail info@civil-comp.com; www.civil-comp.com/conf/ect2006.htm.

13-14 Intl. Conf. on Foam Processing and Technology (FOAMS 2006), *Itasca, IL*. Society of Plastics Engineers, 14 Fairfield Drive, P.O. Box 403, Brookfield, CT 06804-0403; 203-775-0471, fax 203-775-8490; e-mail info@4spe.org; www.4spe.org/conf/foams06/0609foams.php.

OCTOBER 2006

13–15 European Conf. on Residual Stresses (ECRS 7), *Berlin, Germany*. Walter Reimers, Technical University Berlin, Sekr BH-18, Ernst-Reuter-Platz 1, Berlin, Germany, 49-0-30-314-22417; fax 49-0-30-314-22996; e-mail Walter.Reimers@TU-Berlin.de; www.tu-berlin.de/fak3/wewwi/metallische_werkstoffe/ecrs7.

13–15 Intl. Conf. on Engineering Failure Analysis, *Toronto, Ontario*. Claire Norris, ICEFA-II Conference Secretariat 51 Kestrel Way, Wokingham, Berkshire RG41 3HA, UK; 44-0-118-377-4696; fax 44-0-118-977-6680; e-mail icefa@elsevier.com; www.icefa.elsevier.com.

16–20 Thermoforming Conf., *Nashville, TN*. Society of Plastics Engineers, 14 Fairfield Drive, P.O. Box 403, Brookfield, CT 06804-0403; 203-775-0471, fax 203-775-8490; e-mail info@4spe.org; www.4spe.org/conf/thermo06/0609thermo.php.

17–19 Color and Appearance Conf., *Cincinnati, OH*. Society of Plastics Engineers, 14 Fairfield Drive, P.O. Box 403, Brookfield, CT 06804-0403; 203-775-0471, fax 203-775-8490; e-mail info@4spe.org; www.4spe.org/conf.

17–22 Intl. Conf. on Fatigue Damage of Structural Materials, *Hyannis, MA*. Sophie Peters, Elsevier, The Boulevard, Langford Lane, Kidlington, Oxford, UK; 44-0-1865-843643; fax 44-0-1865-843958; e-mail s.peters@elsevier.com; www.fatiguedamage.elsevier.com.

17–22 Workshop on Non Equilibrium Phenomena in Supercooled Fluids, Glasses and Amorphous Materials, *Pisa, Italy*. Laura Andreozzi, Università di Pisa, Largo Pontecorvo n.3, I-56127, Pisa, Italy, 39-050-2214891; fax 39-050-2214890; e-mail workshop4@df.unipi.it; wneqp4.df.unipi.it.

18–20 Materials Science & Technology Conf., *Cincinnati, OH*. Customer Service ASM International, 9639 Kinsman Road, Materials Park, OH, 44073-0002; 800-336-5152 ext 6; fax 440-338-4634; e-mail Customerservice@asminternational.org; www.asminternational.org.

18–21 Environmental Forensics: Chemical, Physical and Biological Methods, *Durham, UK*. RSC Conferences, Thomas Graham House, Science Park, Milton Road, Cambridge CB4 0WF, UK; 44-0-1223-432254; fax 44-0-1223-423623; www.rsc.org/ConferencesAndEvents/RSCConferences/EnvForen.

18–22 Intl. Conf. on the Structure of Non-Crystalline Materials, *Praha, Czech Republic*. Romana Kocova, Icaris Conference Management, m. Dr. Holého 8, 180 00 Praha 8—Liben, Czech Republic; 420-284-823-250; fax 420-266-312-113; e-mail romana@icaris.cz; www.icaris.info/NCM10.

19–20 Silicone Elastomers 2006, *Frankfurt, Germany*. Rapra Technology, Shawbury, Shrewsbury, SY4 4NR, United Kingdom, 44-0-1939-250383; fax 44-0-1939-251118; e-mail conferences@rapra.net; www.rapra.net/conferences/siliconeelastomers06.

20–22 Small Times NanoCon Intl., *Las Vegas, NV*. Kelli Felker, Small Times Media, 655 Phoenix Drive, Ann Arbor, MI, 48108; 734-528-6263; fax 734-994-1554; e-mail kelifelker@smalltimes.com; nce06.events.pennnet.com.

23–26 Intl. Conf. on Inorganic Materials, *Ljubljana, Slovenia*. Nick Williams, Inovar Event Management, Dogpole House, Dogpole, Shrewsbury SY1 1EN, UK, 44-1743-241-289; fax 44-1743-369-660; e-mail im-conference@elsevier.com; www.im-conference.elsevier.com.

24–28 Intl. Symp. on Crystallization in Glasses and Liquids, *Jackson Hole, WY*. The American Ceramic Society, 735 Ceramic Place, Suite 100, Westerville, OH, 43081; 614-890-4700; fax 614-899-6109; e-mail info@ceramics.org; www.ceramics.org/meetings/crystallization.

24–29 Intl. Congress on Solid State Chemistry (SSC 2006), *Pardubice, Czech Republic*. Tomas Wagner, University of Pardubice, Legions Sq. 565, 532 10, Pardubice, Czech Republic, 420-466-037-144; fax 420-466-037-311; e-mail ssc@upce.cz; ssc.upce.cz.

24–29 Process Intensification and Process Innovation—(PI)2 II Cleaner, Sustainable, Efficient Technologies for the Future, *Christchurch, New Zealand*. ECI, 6 Metro Tech Center, Brooklyn, NY, 11201; 718-260-3743; fax 718-260-3754; e-mail info@eci.poly.edu; www.engconfintl.org/6ap.html.

27–28 nanoTX 06, *Dallas, TX*. nanoTX 06, 437 Southfork, Suite 400, Dallas/Fort Worth, TX, 75057; 214-513-9567; fax 866-815-0565; e-mail info@nanotx.biz; www.nanotx.biz.

1–4 Euro Fed Lipid Congress: Lipids, Fats and Oils for a Healthier Future, *Madrid, Spain*. Euro Fed Lipid, P.O. Box 90 04 40, D-60444, Frankfurt/Main, Germany, 49-69-7917-345; fax 49-69-7917-564; e-mail amoneit@eurofedlipid.org; www.eurofedlipid.org/meetings/madrid.

1–5 Metabolic Engineering VI: From recDNA towards Engineering Biological Systems, *Noordwijkerhout, Netherlands*. ECI, 6 Metro Tech Center, Brooklyn, NY, 11201; 718-260-3743; fax 718-260-3754; e-mail info@eci.poly.edu; www.engconfintl.org/6ay.html.

3–6 World Congress on Emulsions, *Lyon, France*. 140 cours Charlemagne, 69002 Lyon, France; 33-0-4-72-77-45-50; fax 33-0-4-72-77-45-77; e-mail cme@package.fr; www.cme-emulsion.com.

4–6 Knowledge Foundation TCA Summit 2006—Innovations in Materials Science for Technology Commercialization, *Washington, DC*. Knowledge Foundation, 18 Webster Street, Brookline, MA, 02446-4938; (617) 232-7400; fax (617) 232-9171; e-mail custserv@knowledgefoundation.com; www.knowledgefoundation.com.

5–6 Fuel Cells Durability and Performance, *Chicago, IL*. Knowledge Foundation, 18 Webster Street, Brookline, MA, 02446-4938; 617-232-7400; fax 617-232-9171; e-mail custserv@knowledgefoundation.com; www.knowledgefoundation.com.

5–7 ACS Northeast Regional Meeting, *Binghamton, NY*. Beverly Johnson, American Chemical Society, Regional Meetings, 1155 Sixteenth Street, Washington, DC 20036; 202-872-6264; e-mail b_johnson@acs.org. **MRS.**

9–11 Intl. Seminar on the Technology of Inherently Conductive Polymers, *Florence, Italy*. Matt Aldissi, Advanced Polymer Courses, 200 9th Avenue North, Suite 100, Safety Harbor, FL, 34695; 727-723-3006; fax 727-723-3007; e-mail maldissi@fractalsystemsinc.com; www.conductivepolymers.com.

9–13 American Society of Human Genetics Annual Meeting, *New Orleans, LA*. Jean Lash, FASEB/OSMC, 9650 Rockville Pike, Bethesda, MD, 20814; 301-634-7009; fax 301-634-7014; e-mail jlash@faseb.org; www.faseb.org/meetings.

10–14 Biomedical Engineering Society 2006 Annual Fall Meeting, *Chicago, IL*. Biomedical Engineering Society, 8401 Corporate Drive, Suite 225, Landover, MD, 20785-2224; 301-459-1999; fax 301-459-2444; e-mail info@bmes.org; www.bmes.org/meetings.asp.

15–18 Fluoropolymer 2006, *Charleston, SC*. Lesia Linkous, Division of Polymer Chemistry Inc., 540-231-3052; e-mail lesiar@vt.edu; www.polyacs.org/arcmeetings/fluoro.1006.shtml.

15–19 Intl. Conf. on LEEM/PEEM, *Himeji, Japan*. Kazuhiro Tohma, 81-791-58-0987; fax 81-791-58-0988; e-mail leem-peem-v@spring8.or.jp; leem-peem-v.spring8.or.jp.

16–19 Material Science and Technology Conf. and Exhibition (MS&T06), *Cincinnati, OH*. The American Ceramic Society, 735 Ceramic Place, Suite 100, Westerville, OH, 43081; 614-890-4700; fax 614-899-6109; e-mail info@ceramics.org; www.ceramics.org/meetings.

17–18 Plastics Additives and Compounding Conf. (Addcon World 2006), *Cologne, Germany*. Rapra Technology, Shawbury, Shrewsbury, SY4 4NR, United Kingdom, 44-0-1939-250383; fax 44-0-1939-251118; e-mail conferences@rapra.net; www.rapra.net/conferences/addcon06.

17–19 Advanced Metallization Conf. (AMC) 2006, *San Diego, CA*. UC Berkeley Extension, Engineering, 1995 University Avenue, #7010, Berkeley, CA, 94720-7000; 510-642-4151; fax 510-642-6027; e-mail amc@unex.berkeley.edu; www.unex.berkeley.edu/eng/metal. **Endorsed.**

19–20 Intl. Activated Carbon Conf., *Pittsburgh, PA*. Henry Nowicki, PACS Testing and Consulting, 409 Meade Drive, Coraopolis, PA, 15108; 724-457-6576; fax 724-457-1214; e-mail hnpacs@aol.com; cbrunning.net/pacs/conferences/IACC/IACC18.htm.

22–27 Gordon Research Conf. on Biointerface Science, *Les Diablerets, Switzerland*. Ashutosh Chilkoti, Duke University, Dept. of Biomedical Engineering, Box 90281, Durham, NC, 27708-0281; e-mail chilkoti@duke.edu; www.grc.org/programs/2006/bioint.htm.

23–24 SPE Engineering Properties and Structure Division (TopCon 2006), *Akron, OH*. Society of Plastics Engineers, 14 Fairfield Drive, P.O. Box 403, Brookfield, CT 06804-0403; 203-775-0471, fax 203-775-8490; e-mail info@4spe.org; www.4spe.org/conf/eps-div06/0610epsdiv.php.

24–25 Plastic Electronics 2006, *Frankfurt, Germany*. Plastic Electronics Foundation, P.O. Box 80, 5600 AB, Eindhoven, Netherlands, 31-6-25072805; fax 31-13-5230324; e-mail info@plastictronics.org; www.plastictronics.org.

29–2 XI Intl. Conf. on the Physics of Non-Crystalline Solids, *Rhodes, Greece*. Vasso Zatta, Institute of Materials Science, NCSR "Demokritos" 1530 10 Aghia Paraskevi Attiki, Greece; 30-210-6503381; fax 30-210-6503323; e-mail vzatta@ims.demokritos.gr; web.ims.demokritos.gr/glass/XI-PNCS.

29–2 Control of Particulate Processes, *Harrison Hot Springs, BC*. ECI, 6 Metro Tech Center, Brooklyn, NY, 11201; 718-260-3743; fax 718-260-3754; e-mail info@eci.poly.edu; www.engconfintl.org/6av.html.

30–2 Intl. Congress of Nanotechnology (ICNT 2006), *San Francisco, CA*. International Association of Nanotechnology, Inc, 2386 Fair Oaks Boulevard, Sacramento, CA, 95825; 916-529-4119; fax 916-421-6366; e-mail info@ianano.org; www.nanotechcongress.com.

30–2 Intl. Congress on Applications of Lasers and Electro-Optics (ICALEO), *Scottsdale, AZ*. Laser Institute of America, 13501 Ingenuity Drive, Suite 128, Orlando, FL, 32826; 407-380-1553; fax 407-380-5588; e-mail bcohen@laserinstitute.org; www.icaleo.org.

30–3 APS Annual DPP Meeting, *Philadelphia, PA*. APS, www.aps.org/meet/calendar.cfm.

NOVEMBER 2006

8–9 Thermoplastic Elastomers Conf. (TPE 2006), *Munich, Germany*. Rapra Technology, Shawbury, Shrewsbury, SY4 4NR, UK; 44-0-1939-250383; fax 44-0-1939-251118; e-mail conferences@rapra.net; www.rapra.net/conferences/tpe06.

12–16 ISTFA Conf. and Exposition, *Austin, TX*. ASM International Customer Service, 9639 Kinsman Road, Materials Park, OH 44073-0002; 800-336-5152 ext. 6; fax 440-338-4634; e-mail customer.service@asminternational.org; www.asminternational.com

13–17 Fuel Cell Seminar 2006, *Honolulu, HI*. Fuel Cell Seminar Headquarters, c/o Courtesy Associates, 2025 M Street, Suite 800, Washington, DC, 20036; 202-973-8671; fax 202-331-0111; e-mail fuelcell@courtesyassoc.com; www.fuelcellseminar.com.

27-31 2006 MRS Fall Meeting, Boston, MA. Materials Research Society, 506 Keystone Drive, Warrendale, PA 15086; 724-779-3003; fax 724-779-8313; e-mail info@mrs.org; www.mrs.org. **MRS.**

DECEMBER 2006

4-5 Intl. Conf. Nanoimprint Lithography Application in Nanosystems and Nanodevices (NanokAP 2006), Miami Beach, FL. Knowledge Foundation, 18 Webster Street, Brookline, MA, 02446-4938; (617) 232-7400; fax (617) 232-9171; e-mail custserv@knowledgefoundation.com; www.knowledgefoundation.com.

5-6 RubberChem 2006, Munich, Germany. Rapra Technology Limited, RAPRA, Rapra Technology, Shawbury, Shrewsbury, SY4 4NR, UK, 44-1939-250383; fax 44-1939-251118; e-mail conferences@rapra.net; www.rapra.net/conferences/rubberchem06.

10-13 Intl. Conf. on Advanced Materials and Processing (ICAMP-4), Hamilton, New Zealand. The University of Waikato, Advanced Materials & Processing Conference, Private Bag 3105, Hamilton, New Zealand, fax 64-7-838 4835; e-mail icamp@waikato.ac.nz; mape.waikato.ac.nz/icamp.

14-16 Flexible Packaging Conf. (FlexPackCon 2006), Orlando, FL. Society of Plastics Engineers, 14 Fairfield Drive, P.O. Box 403, Brookfield, CT 06804-0403; 203-775-0471, fax 203-775-8490; e-mail info@4spe.org; www.4spe.org/conf/flexpack06.

FEBRUARY 2007

20-23 Intl. Conf. on Recent Advances in Composite Materials (ICRACM), New Delhi, India. V.K. Srivastava, ICRACM-2007, Dept. of Mechanical Engineering, Institute of Technology, Banaras Hindu University, Varanasi-221005, India; 91-542-2368157; e-mail vijays_sa@yahoo.com; www.htu.ac.in/notification/icracm.htm.

22-23 Intl. Conf. on Nanoimprint Lithography Application in Nanosystems and Nanodevices, Miami Beach, FL. Knowledge Foundation, 18 Webster Street, Brookline, MA, 02446-4938; 617-232-7400; fax 617-232-9171; e-mail custserv@knowledgefoundation.com; www.knowledgefoundation.com.

25-1 2007 TMS Annual Meeting and Exhibition, Orlando, FL. TMS Meetings Services, 184 Thorn Hill Road, Warrendale, PA, 15086; 724-776-9000 x243; fax 724-776-3770; e-mail mtgserv@tms.org; www.tms.org/meetings/meetings.asp.

MARCH 2007

3-7 Biophysical Society Annual Meeting, Baltimore, MD. www.biophysics.org/meetings/future.htm.

5-9 APS March Meeting 2007, Denver, CO. APS, www.aps.org/meet/calendar.cfm.

14-15 European Additives and Colors Conf., Luxembourg. Yetty Pauwels, SPE European Member Bureau, Eric Sasselaan 51, BE-2020 Antwerpen, Belgium, 32-3-541-77-55; fax 32-3-541-84-25; e-mail spe.europe@skynet.be; www.speurope.org.

19-22 Intl. Laser Safety Conf. (ILSC), San Francisco, CA. Laser Institute of America, 13501 Ingenuity Drive, Suite 128, Orlando, FL, 32826; 407-380-1553; fax 407-380-5588; e-mail bcohen@laserinstitute.org; www.laserinstitute.org/conferences/ilsc.

25-29 ACS National Meeting & Exposition, Chicago, IL. American Chemical Society, attn: National Expositions, 1155 Sixteenth Street, Washington, DC 20036; e-mail expo@acs.org; chemistry.org/expositions.

APRIL 2007

2-5 15th Intl. Conf. on Microscopy of Semiconducting Materials, Cambridge, UK. Endorsed.

9-13 2007 MRS Spring Meeting, San Francisco, CA. Materials Research Society, 506 Keystone Drive, Warrendale; 724-779-3003; fax 724-779-8313; e-mail info@mrs.org; www.mrs.org. **MRS.**

14-17 APS April Meeting 2007, Jacksonville, FL. APS, www.aps.org/meet/calendar.cfm.

28-2 Experimental Biology 2007 Annual Meeting, Washington, DC. Jean Lash, FASEB/OSMC, 9650 Rockville Pike, Bethesda, MD, 20814; 301-634-7009; fax 301-634-7014; e-mail jlash@faseb.org; www.faseb.org/meetings.

28-3 SVC Annual Technical Conf., Louisville, KY. SVC—Society of Vacuum Coaters, 71 Pinon Hill Place NE, Albuquerque, NM 87122, 505-856-7188; fax 505-856-7616; e-mail svcinfo@svc.org; www.svc.org.

MAY 2007

13-17 MPIF Intl. Conf. on Powder Metallurgy and Particulate Materials (PowderMet 2007), Denver, CO. MPIF, 105 College Road East, Princeton, NJ, 08540; 609-452-7700; fax 609-987-8523; e-mail info@mpif.org; www.mpiif.org.

27-31 10th Intl. Conf. on the Mechanical Behavior of Materials, Seoul, Korea. JC International, Twin Tower B #1008, 275-4 Yangjae-dong, Seocho-gu, 137-130 Seoul, Korea, 82-2-571-2724; fax 82-2-571-2721; e-mail jcpark@jcenter.co.kr; icm10.org.

JUNE 2007

5-9 APS Annual Division of Atomic, Molecular and Optical Physics Meeting, Calgary, Alberta. APS, www.aps.org/meet/calendar.cfm.

25-28 ECM VIII: Bone Tissue Engineering, Davos, Switzerland. Sonia Wahl, AO Research Institute, Clavadelerstrasse, CH-7270 Davos Platz, Davos, Switzerland, 41-81-41-42-541; fax 41-81-41-42-299; e-mail sonia.wahl@aofoundation.org; www.ecmjournal.org/ecm_meetings/next_event.shtml.

JULY 2007

2-6 Intl. Congress on Glass, Strasbourg, France. ICG 2007, CRIT Materiaux Alsace, 19 rue de Saint Junien, BP 23, F67305 Schiltigheim Cedex, France; 33-0-3-88-19-15-10; fax 33-0-3-88-19-15-14; e-mail info@icg2007.org; www.icg2007.org.

AUGUST 2007

6-9 Microscopy and Micro-analysis 2007, Ft. Lauderdale, FL. Microscopy/Marketing & Education, Inc., Meeting Management Microscopy & Microanalysis, 125 Parido Street, Suite 102, Springfield, MA, 01118-2130; 972-954-8011; fax 972-954-8018; e-mail corporate@mme1.com; microscopy.org/MMMeetings.

19-23 ACS National Meeting and Exposition, Boston, MA. American Chemical Society, ATTN: National Expositions, 1155 Sixteenth Street, Washington, DC 20036; e-mail expo@acs.org; chemistry.org/expositions.

SEPTEMBER 2007

16-19 Euro Fed Lipid Congress, Göteborg, Sweden. Euro Fed Lipid, P.O. Box 90 04 40, D-60444, Frankfurt/Main, Germany, 49-69-7917-345; fax 49-69-7917-564; e-mail amoneit@eurofedlipid.org; www.eurofedlipid.org/meetings/goeteborg.

OCTOBER 2007

8-9 Knowledge Foundation TCA Summit 2007—Innovations in Materials Science for Technology Commercialization, Washington, DC. Knowledge Foundation, 18 Webster Street, Brookline, MA, 02446-4938; 617-232-7400; fax 617-232-9171; e-mail custserv@knowledgefoundation.com; www.knowledgefoundation.com.

8-13 Intl. Conf. on Advanced Materials (IUMRS-ICAM 2007), Bangalore, India. Secretariat IUMRS-ICAM-2007, Materials Research Society of India, Bangalore, India, 91-080-22932882; fax 91-080-23602028; e-mail secretariat@icam2007.com; www.icam2007.com. **IUMRS/MRS-I.**

NOVEMBER 2007

12-16 APS Annual DPP Meeting, Orlando, FL. APS, www.aps.org/meet/calendar.cfm.

26-30 2007 MRS Fall Meeting, Boston, MA. Materials Research Society, 506 Keystone Drive, Warrendale, 724-779-3003; fax 724-779-8313; e-mail info@mrs.org; http://www.mrs.org. **MRS.**

MARCH 2008

10-14 APS March Meeting 2008, New Orleans, LA. APS, www.aps.org/meet/calendar.cfm.

24-28 2008 MRS Spring Meeting, San Francisco, CA. Materials Research Society, 506 Keystone Drive, Warrendale, 724-779-3003; fax 724-779-8313; e-mail info@mrs.org; www.mrs.org. **MRS.**

APRIL 2008

3-9 Experimental Biology 2008 Annual Meeting, San Diego, CA. Jean Lash, FASEB/OSMC, 9650 Rockville Pike, Bethesda, MD, 20814; 301-634-7009; fax 301-634-7014; e-mail jlash@faseb.org; www.faseb.org/meetings.

12-15 APS April Meeting 2008, St. Louis, MO. APS, www.aps.org/meet/calendar.cfm.

19-26 SVC Annual Technical Conf., Chicago, IL. SVC—Society of Vacuum Coaters, 71 Pinon Hill Place NE, Albuquerque, NM 87122, 505-856-7188; fax 505-856-7616; e-mail svcinfo@svc.org; www.svc.org.

MAY 2008

28-1 World Biomaterials Congress, Amsterdam, Netherlands. Secretariat World Biomaterials Congress, International Conference Services, P.O. Box 83005, 1080 AA, Amsterdam, Netherlands, 31-0-206793218; fax 31-0-206758236; e-mail info.wbc2008@ics-online.nl; www.wbc2008.com.

JUNE 2008

8-12 MPIF Intl. Conf. on Powder Metallurgy and Particulate Materials (PowderMet 2008), Washington, DC. MPIF, 105 College Road East, Princeton, NJ, 08540; 609-452-7700; fax 609-987-8523; e-mail info@mpif.org; www.mpiif.org.

23-26 ECM IX Fifty Years of AO: Internal Fixation: From Research to the Clinics, Davos, Switzerland. Sonia Wahl, AO Research Institute, Clavadelerstrasse, CH-7270 Davos Platz, Davos, Switzerland, 41-81-41-42-541; fax 41-81-41-42-299; e-mail sonia.wahl@aofoundation.org; www.ecmjournal.org/ecm_meetings/next_event.shtml.

NOVEMBER 2008

17-21 APS Annual DPP Meeting, Dallas, TX. APS, www.aps.org/meet/calendar.cfm.

23-26 ECM IX Fifty Years of AO: Internal Fixation: From Research to the Clinics, Davos, Switzerland. Sonia Wahl, AO Research Institute, Clavadelerstrasse, CH-7270 Davos Platz, Davos, Switzerland, 41-81-41-42-541; fax 41-81-41-42-299; e-mail sonia.wahl@aofoundation.org; www.ecmjournal.org/ecm_meetings/next_event.shtml.

DECEMBER 2008

1-5 2008 MRS Fall Meeting, Boston, MA. Materials Research Society, 506 Keystone Drive, Warrendale, 724-779-3003; fax 724-779-8313; e-mail info@mrs.org; www.mrs.org. **MRS.**

MARCH 2009

16-20 APS March Meeting 2009, Pittsburgh, PA. APS, www.aps.org/meet/calendar.cfm.

APRIL 2009

13-17 2009 MRS Spring Meeting, San Francisco, CA. Materials Research Society, 506 Keystone Drive, Warrendale, 724-779-3003; fax 724-779-8313; e-mail info@mrs.org; www.mrs.org. **MRS.**

17-22 Experimental Biology 2009 Annual Meeting, New Orleans, LA. FASEB/OSMC, Jean Lash, 9650 Rockville Pike, Bethesda, MD, 20814; 301-634-7009; fax 301-634-7014; e-mail jlash@faseb.org; www.faseb.org/meetings. □